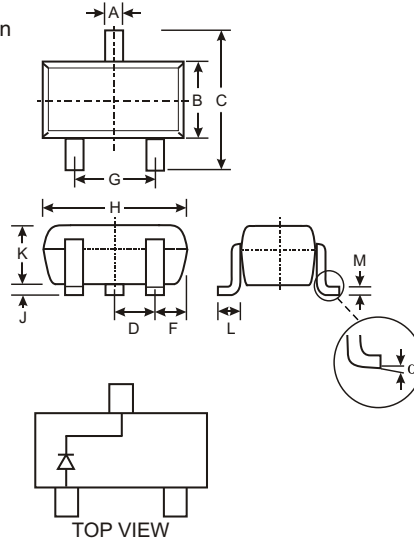


### Features

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose Switching Applications
- High Conductance
- Lead Free/RoHS Compliant (Note 3)**
- "Green" Device (Note 4 and 5)**

### Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 5. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagram
- Marking: KA1 (See Page 2)
- Weight: 0.006 grams (approximate)



SOT-323		
Dim	Min	Max
A	0.25	0.40
B	1.15	1.35
C	2.00	2.20
D	0.65 Nominal	
E	0.30	0.40
G	1.20	1.40
H	1.80	2.20
J	0.0	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.18
	0	8
All Dimensions in mm		

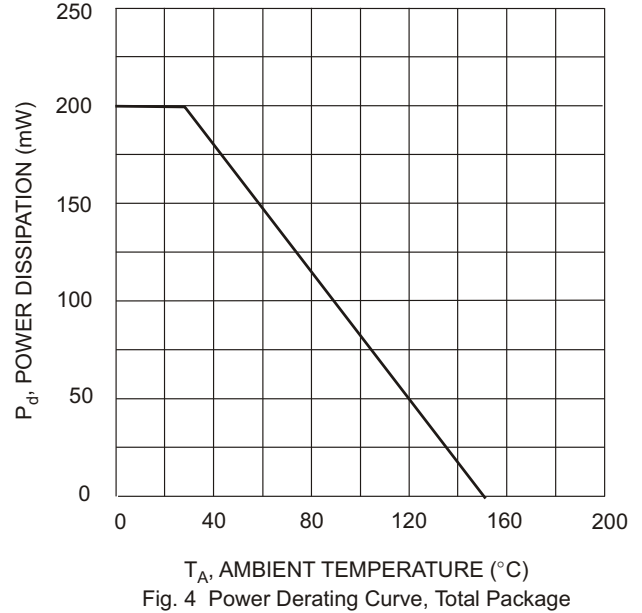
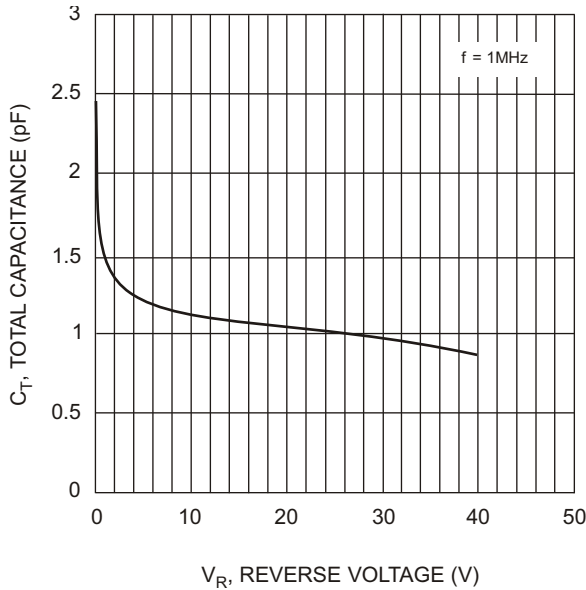
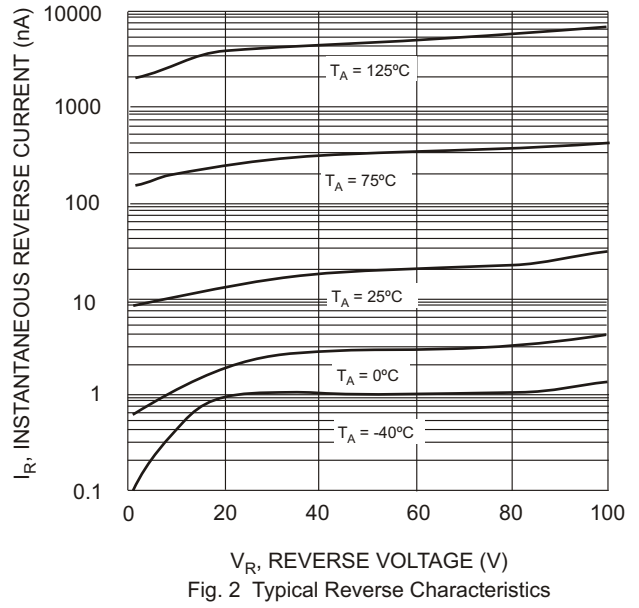
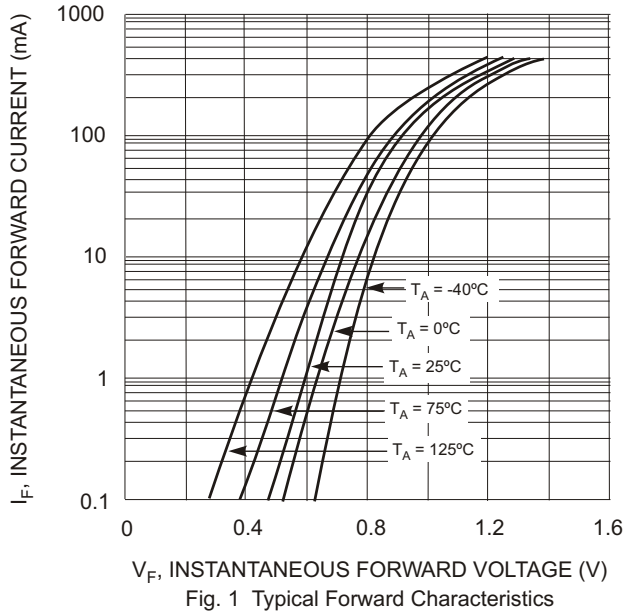
### Maximum Ratings @ T<sub>A</sub> = 25 C unless otherwise specified

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V <sub>RM</sub>	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	80	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	57	V
Forward Continuous Current (Note 1)	I <sub>FM</sub>	500	mA
Average Rectified Output Current (Note 1)	I <sub>O</sub>	250	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0 s @ t = 1.0s	I <sub>FSM</sub>	4.0 2.0	A
Power Dissipation (Note 1)	P <sub>d</sub>	200	mW
Thermal Resistance Junction to Ambient Air (Note 1)	R <sub>JA</sub>	625	C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	C

### Electrical Characteristics @ T<sub>A</sub> = 25 C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	V <sub>(BR)R</sub>	80		V	I <sub>R</sub> = 2.5 A
Forward Voltage	V <sub>F</sub>	0.62	0.72 0.855 1.0 1.25	V	I <sub>F</sub> = 5.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 100mA I <sub>F</sub> = 150mA
Peak Reverse Current (Note 2)	I <sub>R</sub>		100 50 30 25	nA A A nA	V <sub>R</sub> = 70V V <sub>R</sub> = 75V, T <sub>J</sub> = 150 C V <sub>R</sub> = 25V, T <sub>J</sub> = 150 C V <sub>R</sub> = 20V
Total Capacitance	C <sub>T</sub>		3.5	pF	V <sub>R</sub> = 6V, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>		4.0	ns	V <sub>R</sub> = 6V, I <sub>F</sub> = 5mA

- Notes: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
2. Short duration test pulse used to minimize self-heating effect.
3. No purposefully added lead.
4. Diodes Inc.'s "Green" policy can be found on our website at [http://www.diodes.com/products/lead\\_free/index.php](http://www.diodes.com/products/lead_free/index.php).
5. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

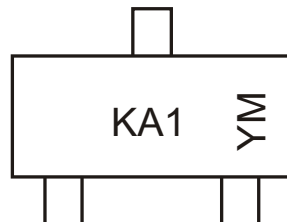


### Ordering Information (Note 5 & 6)

Device	Packaging	Shipping
MMBD4448HW-7-F	SOT-323	3000/Tape & Reel

- Notes: 5. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.  
 6. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

### Marking Information



KA1= Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year ex: N = 2002  
 M = Month ex: 9 = September

#### Date Code Key

Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	M	N	P	R	S	T	U	V	W	X	Y	Z
Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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